IntraGRAPH HS

Thermally Conductive Graphite Foil (uncoated)

In-Plane Thermal Conductivity: 140 W/m-K

IntraGraph HS consists of more than 98% pure graphite designed with a flake like structure exhibiting anisotropic thermal conductivity in-plane (XY) and in the thru direction (Z). IntraGraph HS offers a soft compliance allowing for excellent contact of surfaces further reducing thermal resistance.

IntraGraph HS Foil's low density compared to copper (15%) or aluminum (50%) make it ideal for applications where either a low weight TIM design is required, very high temperature resistance or efficient in-plane heat dissipation is needed. In comparison to typical graphite foils in the market place, IntraGraph HS offers easy handling (foil itself) without worry of shattering or breaking of the foil during installation.

IntraGraph HS is readily available at 2 standard foil thicknesses in rolls, sheets or die cut to a specific customer required outline. For pre-apply options, IntraGraph HS is available with low tack repositionable pressure sensitive mounting adhesive one side for quick pad placement or vertical mount assemblies. Special multi-layer configurations are available through the use of dielectric barrier film layers (PET, polyimide, thermally conductive silicone films and gap pad).

Excellent Surface Contact with Soft Foil Design
Low Weight Foil Design with Easy Handling

Very High Temperature Resistant

- Low Cost TIM Solution
- EMI-Shielding Application
- Flexible Multi-Layer Design

Typical Applications

- LED Assembly
- Heat Sinks
- Power Inverters

- Automotive Power Supplies
 - Industrial Power Supplies

CPU Microprocessor

Standard Thickness Options

GF.13	0.005" (0.127mm)
GF.25	0.010" (0.254mm)

IntraGraph HS General Properties

Color:	Gray
Hardness	85 (shore A)
Volume Resistivity	11.0 x 10 ⁻⁴ (ohm-cm)
Dielectric Constant	< 0.001 (@1 MHz)
Operating Temperature	240°C to 300°C

Type GF.13 Specific Properties

Thermal Conductivity (XY—In Plane)	140 W/m-K
Thermal Conductivity (Z—Through Plane)	8 W/m-K
Thermal Impedance @ 10 PSI0	0.120 °C in² / Watt
Thermal Impedance @ 30 PSI0	0.090 °C in² / Watt
Thermal Impedance @ 150 PSI	0.060 °C in² / Watt

Type GF.25 Specific Properties

Thermal Conductivity (XY—In Plane)	140 W/m-K
Thermal Conductivity (Z—Through Plane)	8 W/m-K
Thermal Impedance @ 10 PSI0.240	°C in² / Watt
Thermal Impedance @ 30 PSI0.160	°C in² / Watt
Thermal Impedance @ 150 PSI0.100	°C in ² / Watt

IntraGraph HS Pre-Apply Attachment Options

LT.....low tack pressure sensitive (repositionable) A....,medium tack pressure sensitive (repositionable) T20.....thermally conductive pressure sensitive

Discrete PSA placement or 100% backed options

IntraGraph HS Delivery Formats

Master rolls Sheets Die cut individuals Multiple die cuts per card Die cut continuous reels Laser Cutting (Tight Tolerance)

Characteristic	IntraGraph HS
Base Material	Anisotropic 98% Pure Graphite Foil
Color	Gray
Available Formats	Rolls, Sheets, Die Cuts
Standard Roll Size	11.81" x 164ft
Standard Sheet Size	11.81" x 24.00"
Adhesive Backing Options	Type A or LT (12.5 micron repositionable)
	Type T20 (50 micron thermally conductive)
Barrier Backing Options	PET Film (0.001" to 0.010")
Dielectric and Non-Dielectric Options	Polyimide Film (0.001" to 0.005")
	Foils (AL, CU, Stainless) (0.001" to 0.005")
	Thermally Conductive Silicone Films and Gap Pads
Coating Options (Phase Change)	Yes, thermally conductive phase change compound coated (1 or 2 sides) - further reduction in surface resistance—Contact TIMTEL for more information
TIMTEL Die Cut Dimensional Tolerances	0.010"(0.25mm) to 0.020"(0.51mm) (depending on thickness
Storage	Cool, dry location at or below 80F/ 27C
Shelf Life	2 years from date of manufacture

Thermal material evaluation is always critical when designing in a new material or developing a new product. Sheet samples of IntraGraph HS are available for preliminary testing to determine the optimal IntraGraph HS thickness as well as overall material construction best suited within the scope of your application requirements.





Standard IntraGraph HS Cross Section

IntraGraph HS Substrate Only

Adhesive Attachment Options

IntraGraph HS Substrate

Type LT or A = 12.5 micron (repositionable) Type: T20 (50 microns)

Barrier Options (with or without adhesive option)

IntraGraph HS Substrate

PET Films, Polyimide Films, Foils, Thermally Conductive Silicone Pad